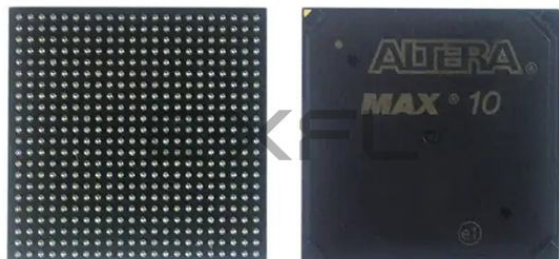


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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)



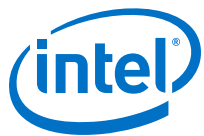
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

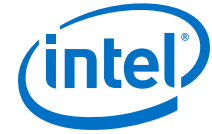
|                                |                                                                                                                                   |
|--------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|
| Product Status                 | Active                                                                                                                            |
| Number of LABs/CLBs            | 1000                                                                                                                              |
| Number of Logic Elements/Cells | 16000                                                                                                                             |
| Total RAM Bits                 | 562176                                                                                                                            |
| Number of I/O                  | 246                                                                                                                               |
| Number of Gates                | -                                                                                                                                 |
| Voltage - Supply               | 1.15V ~ 1.25V                                                                                                                     |
| Mounting Type                  | Surface Mount                                                                                                                     |
| Operating Temperature          | 0°C ~ 85°C (TJ)                                                                                                                   |
| Package / Case                 | 324-LFBGA                                                                                                                         |
| Supplier Device Package        | 324-UBGA (15x15)                                                                                                                  |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/intel/10m16dcu324c8g">https://www.e-xfl.com/product-detail/intel/10m16dcu324c8g</a> |



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## Intel® MAX® 10 FPGA Device Datasheet

This datasheet describes the electrical characteristics, switching characteristics, configuration specifications, and timing for Intel MAX® 10 devices.

**Table 1. Intel MAX 10 Device Grades and Speed Grades Supported**

| Device Grade | Speed Grade Supported                                                        |
|--------------|------------------------------------------------------------------------------|
| Commercial   | <ul style="list-style-type: none"> <li>–C7</li> <li>–C8 (slowest)</li> </ul> |
| Industrial   | <ul style="list-style-type: none"> <li>–I6 (fastest)</li> <li>–I7</li> </ul> |
| Automotive   | <ul style="list-style-type: none"> <li>–A6</li> <li>–A7</li> </ul>           |

**Note:** The –I6 and –A6 speed grades of the Intel MAX 10 FPGA devices are not available by default in the Intel Quartus® Prime software. Contact your local Intel sales representatives for support.

### Related Information

[Device Ordering Information, Intel MAX 10 FPGA Device Overview](#)

Provides more information about the densities and packages of devices in the Intel MAX 10.

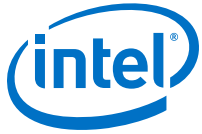
## Electrical Characteristics

The following sections describe the operating conditions and power consumption of Intel MAX 10 devices.

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\*Other names and brands may be claimed as the property of others.

ISO  
9001:2008  
Registered



| Condition (V) | Overshoot Duration as % of High Time | Unit |
|---------------|--------------------------------------|------|
| 4.32          | 2.6                                  | %    |
| 4.37          | 1.6                                  | %    |
| 4.42          | 1.0                                  | %    |
| 4.47          | 0.6                                  | %    |
| 4.52          | 0.3                                  | %    |
| 4.57          | 0.2                                  | %    |

## Recommended Operating Conditions

This section lists the functional operation limits for the AC and DC parameters for Intel MAX 10 devices. The tables list the steady-state voltage values expected from Intel MAX 10 devices. Power supply ramps must all be strictly monotonic, without plateaus.

### Single Supply Devices Power Supplies Recommended Operating Conditions

**Table 6. Power Supplies Recommended Operating Conditions for Intel MAX 10 Single Supply Devices**

| Symbol                             | Parameter                                                              | Condition | Min        | Typ     | Max        | Unit |
|------------------------------------|------------------------------------------------------------------------|-----------|------------|---------|------------|------|
| V <sub>CC_ONE</sub> <sup>(1)</sup> | Supply voltage for core and periphery through on-die voltage regulator | —         | 2.85/3.135 | 3.0/3.3 | 3.15/3.465 | V    |
| V <sub>CCIO</sub> <sup>(2)</sup>   | Supply voltage for input and output buffers                            | 3.3 V     | 3.135      | 3.3     | 3.465      | V    |
|                                    |                                                                        | 3.0 V     | 2.85       | 3       | 3.15       | V    |
|                                    |                                                                        | 2.5 V     | 2.375      | 2.5     | 2.625      | V    |
|                                    |                                                                        | 1.8 V     | 1.71       | 1.8     | 1.89       | V    |
|                                    |                                                                        | 1.5 V     | 1.425      | 1.5     | 1.575      | V    |
| continued...                       |                                                                        |           |            |         |            |      |

(1)  $V_{CCA}$  must be connected to  $V_{CC\_ONE}$  through a filter.

(2)  $V_{CCIO}$  for all I/O banks must be powered up during user mode because  $V_{CCIO}$  I/O banks are used for the ADC and I/O functionalities.



## DC Characteristics

### Supply Current and Power Consumption

Intel offers two ways to estimate power for your design—the Excel-based Early Power Estimator (EPE) and the Intel Quartus Prime Power Analyzer feature.

Use the Excel-based EPE before you start your design to estimate the supply current for your design. The EPE provides a magnitude estimate of the device power because these currents vary greatly with the usage of the resources.

The Intel Quartus Prime Power Analyzer provides better quality estimates based on the specifics of the design after you complete place-and-route. The Power Analyzer can apply a combination of user-entered, simulation-derived, and estimated signal activities that, when combined with detailed circuit models, yield very accurate power estimates.

#### Related Information

- [Early Power Estimator User Guide](#)  
Provides more information about power estimation tools.
- [Power Analysis chapter, Intel Quartus Prime Handbook](#)  
Provides more information about power estimation tools.

### I/O Pin Leakage Current

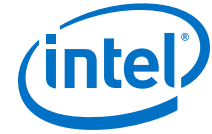
The values in the table are specified for normal device operation. The values vary during device power-up. This applies for all  $V_{CCIO}$  settings (3.3, 3.0, 2.5, 1.8, 1.5, 1.35, and 1.2 V).

10  $\mu$ A I/O leakage current limit is applicable when the internal clamping diode is off. A higher current can be the observed when the diode is on.

Input channel leakage of ADC I/O pins due to hot socket is up to maximum of 1.8 mA. The input channel leakage occurs when the ADC IP core is enabled or disabled. This is applicable to all Intel MAX 10 devices with ADC IP core, which are 10M04, 10M08, 10M16, 10M25, 10M40, and 10M50 devices. The ADC I/O pins are in Bank 1A.

**Table 10. I/O Pin Leakage Current for Intel MAX 10 Devices**

| Symbol   | Parameter                         | Condition                                  | Min | Max | Unit          |
|----------|-----------------------------------|--------------------------------------------|-----|-----|---------------|
| $I_I$    | Input pin leakage current         | $V_I = 0 \text{ V to } V_{CCIO\text{MAX}}$ | -10 | 10  | $\mu\text{A}$ |
| $I_{OZ}$ | Tristated I/O pin leakage current | $V_O = 0 \text{ V to } V_{CCIO\text{MAX}}$ | -10 | 10  | $\mu\text{A}$ |



**Table 17. Internal Weak Pull-Up Resistor for Intel MAX 10 Devices**

Pin pull-up resistance values may be lower if an external source drives the pin higher than  $V_{CCIO}$ .

| Symbol          | Parameter                                                                                                                                                                   | Condition                          | Min | Typ | Max | Unit       |
|-----------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------|-----|-----|-----|------------|
| R <sub>PU</sub> | Value of I/O pin (dedicated and dual-purpose) pull-up resistor before and during configuration, as well as user mode if the programmable pull-up resistor option is enabled | $V_{CCIO} = 3.3 \text{ V} \pm 5\%$ | 7   | 12  | 34  | k $\Omega$ |
|                 |                                                                                                                                                                             | $V_{CCIO} = 3.0 \text{ V} \pm 5\%$ | 8   | 13  | 37  | k $\Omega$ |
|                 |                                                                                                                                                                             | $V_{CCIO} = 2.5 \text{ V} \pm 5\%$ | 10  | 15  | 46  | k $\Omega$ |
|                 |                                                                                                                                                                             | $V_{CCIO} = 1.8 \text{ V} \pm 5\%$ | 16  | 25  | 75  | k $\Omega$ |
|                 |                                                                                                                                                                             | $V_{CCIO} = 1.5 \text{ V} \pm 5\%$ | 20  | 36  | 106 | k $\Omega$ |
|                 |                                                                                                                                                                             | $V_{CCIO} = 1.2 \text{ V} \pm 5\%$ | 33  | 82  | 179 | k $\Omega$ |

## Hot-Socketing Specifications

**Table 18. Hot-Socketing Specifications for Intel MAX 10 Devices**

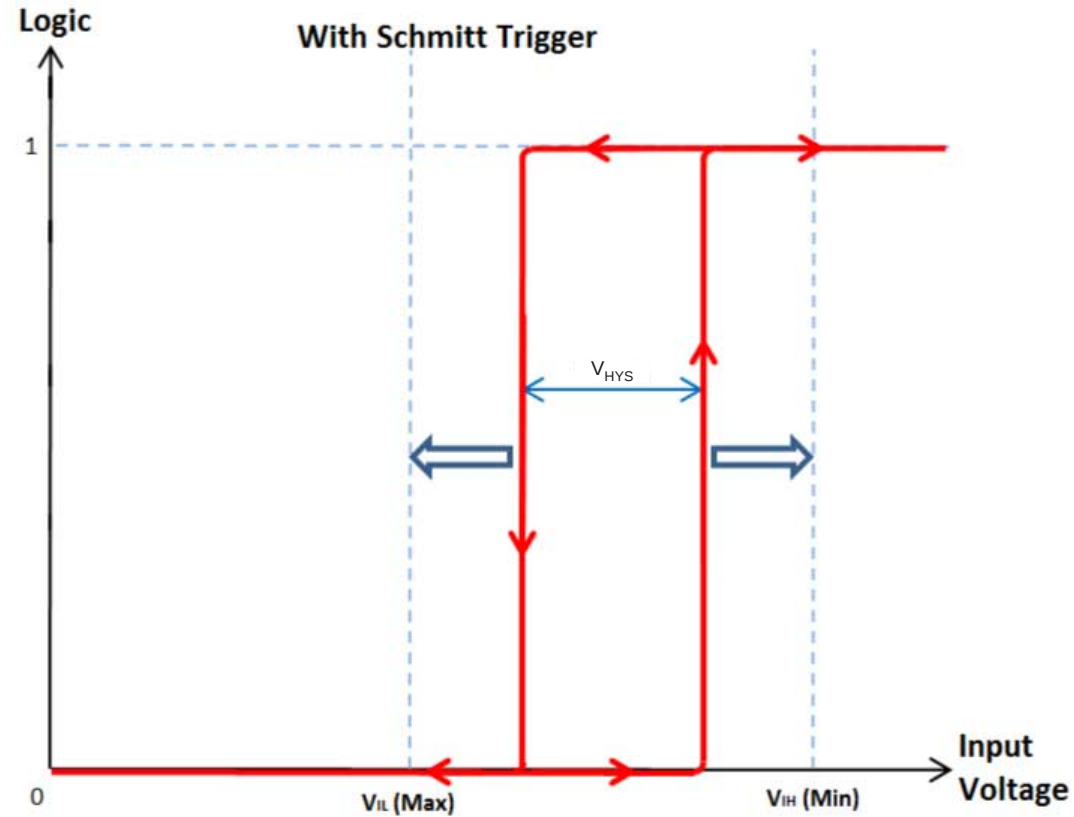
| Symbol                 | Parameter              | Maximum              |
|------------------------|------------------------|----------------------|
| I <sub>IOPIN(DC)</sub> | DC current per I/O pin | 300 $\mu$ A          |
| I <sub>IOPIN(AC)</sub> | AC current per I/O pin | 8 mA <sup>(13)</sup> |

## Hysteresis Specifications for Schmitt Trigger Input

Intel MAX 10 devices support Schmitt trigger input on all I/O pins. A Schmitt trigger feature introduces hysteresis to the input signal for improved noise immunity, especially for signal with slow edge rate.

<sup>(13)</sup> The I/O ramp rate is 10 ns or more. For ramp rates faster than 10 ns,  $|I_{IOPIN}| = C \, dv/dt$ , in which C is I/O pin capacitance and  $dv/dt$  is the slew rate.

Figure 4. Schmitt Trigger Input Standard Voltage Diagram

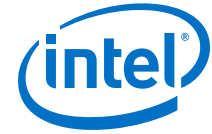


### I/O Standards Specifications

Tables in this section list input voltage ( $V_{IH}$  and  $V_{IL}$ ), output voltage ( $V_{OH}$  and  $V_{OL}$ ), and current drive characteristics ( $I_{OH}$  and  $I_{OL}$ ) for various I/O standards supported by Intel MAX 10 devices.

For minimum voltage values, use the minimum  $V_{CCIO}$  values. For maximum voltage values, use the maximum  $V_{CCIO}$  values.

You must perform timing closure analysis to determine the maximum achievable frequency for general purpose I/O standards.



**Table 24. Differential HSTL and HSUL I/O Standards Specifications for Intel MAX 10 Devices**

| I/O Standard        | V <sub>CCIO</sub> (V) |     |       | V <sub>DIF(DC)</sub> (V) |                   | V <sub>X(AC)</sub> (V)         |                         |                                | V <sub>CM(DC)</sub> (V)  |                         |                          | V <sub>DIF(AC)</sub> (V) |
|---------------------|-----------------------|-----|-------|--------------------------|-------------------|--------------------------------|-------------------------|--------------------------------|--------------------------|-------------------------|--------------------------|--------------------------|
|                     | Min                   | Typ | Max   | Min                      | Max               | Min                            | Typ                     | Max                            | Min                      | Typ                     | Max                      | Min                      |
| HSTL-18 Class I, II | 1.71                  | 1.8 | 1.89  | 0.2                      | —                 | 0.85                           | —                       | 0.95                           | 0.85                     | —                       | 0.95                     | 0.4                      |
| HSTL-15 Class I, II | 1.425                 | 1.5 | 1.575 | 0.2                      | —                 | 0.71                           | —                       | 0.79                           | 0.71                     | —                       | 0.79                     | 0.4                      |
| HSTL-12 Class I, II | 1.14                  | 1.2 | 1.26  | 0.16                     | V <sub>CCIO</sub> | 0.48 × V <sub>CCIO</sub>       | 0.5 × V <sub>CCIO</sub> | 0.52 × V <sub>CCIO</sub>       | 0.48 × V <sub>CCIO</sub> | 0.5 × V <sub>CCIO</sub> | 0.52 × V <sub>CCIO</sub> | 0.3                      |
| HSUL-12             | 1.14                  | 1.2 | 1.3   | 0.26                     | —                 | 0.5 × V <sub>CCIO</sub> – 0.12 | 0.5 × V <sub>CCIO</sub> | 0.5 × V <sub>CCIO</sub> + 0.12 | 0.4 × V <sub>CCIO</sub>  | 0.5 × V <sub>CCIO</sub> | 0.6 × V <sub>CCIO</sub>  | 0.44                     |

#### Differential I/O Standards Specifications

**Table 25. Differential I/O Standards Specifications for Intel MAX 10 Devices**

| I/O Standard           | V <sub>CCIO</sub> (V) |     |       | V <sub>ID</sub> (mV) |     | V <sub>ICM</sub> (V) <sup>(18)</sup> |                                        |      | V <sub>OD</sub> (mV) <sup>(19)(20)</sup> |     |     | V <sub>OS</sub> (V) <sup>(19)</sup> |      |       |
|------------------------|-----------------------|-----|-------|----------------------|-----|--------------------------------------|----------------------------------------|------|------------------------------------------|-----|-----|-------------------------------------|------|-------|
|                        | Min                   | Typ | Max   | Min                  | Max | Min                                  | Condition                              | Max  | Min                                      | Typ | Max | Min                                 | Typ  | Max   |
| LVPECL <sup>(21)</sup> | 2.375                 | 2.5 | 2.625 | 100                  | —   | 0.05                                 | D <sub>MAX</sub> ≤ 500 Mbps            | 1.8  | —                                        | —   | —   | —                                   | —    | —     |
|                        |                       |     |       |                      |     | 0.55                                 | 500 Mbps ≤ D <sub>MAX</sub> ≤ 700 Mbps | 1.8  |                                          |     |     |                                     |      |       |
|                        |                       |     |       |                      |     | 1.05                                 | D <sub>MAX</sub> > 700 Mbps            | 1.55 |                                          |     |     |                                     |      |       |
| LVDS                   | 2.375                 | 2.5 | 2.625 | 100                  | —   | 0.05                                 | D <sub>MAX</sub> ≤ 500 Mbps            | 1.8  | 247                                      | —   | 600 | 1.125                               | 1.25 | 1.375 |
|                        |                       |     |       |                      |     | 0.55                                 | 500 Mbps ≤ D <sub>MAX</sub> ≤ 700 Mbps | 1.8  |                                          |     |     |                                     |      |       |

*continued...*

<sup>(18)</sup> V<sub>IN</sub> range: 0 V ≤ V<sub>IN</sub> ≤ 1.85 V.

<sup>(19)</sup> R<sub>L</sub> range: 90 ≤ R<sub>L</sub> ≤ 110 Ω.

<sup>(20)</sup> Low V<sub>OD</sub> setting is only supported for RSDS standard.

<sup>(21)</sup> LVPECL input standard is only supported at clock input. Output standard is not supported.



| I/O Standard | V <sub>CCIO</sub> (V) |     |       | V <sub>ID</sub> (mV) |     | V <sub>ICM</sub> (V) <sup>(18)</sup> |                                        |      | V <sub>OD</sub> (mV) <sup>(19)(20)</sup> |     |     | V <sub>OS</sub> (V) <sup>(19)</sup> |     |     |
|--------------|-----------------------|-----|-------|----------------------|-----|--------------------------------------|----------------------------------------|------|------------------------------------------|-----|-----|-------------------------------------|-----|-----|
|              | Min                   | Typ | Max   | Min                  | Max | Min                                  | Condition                              | Max  | Min                                      | Typ | Max | Min                                 | Typ | Max |
| HiSpi        | 2.375                 | 2.5 | 2.625 | 100                  | —   | 0.05                                 | D <sub>MAX</sub> ≤ 500 Mbps            | 1.8  | —                                        | —   | —   | —                                   | —   | —   |
|              |                       |     |       |                      |     | 0.55                                 | 500 Mbps ≤ D <sub>MAX</sub> ≤ 700 Mbps | 1.8  |                                          |     |     |                                     |     |     |
|              |                       |     |       |                      |     | 1.05                                 | D <sub>MAX</sub> > 700 Mbps            | 1.55 |                                          |     |     |                                     |     |     |

### Related Information

[Intel MAX 10 LVDS SERDES I/O Standards Support, Intel MAX 10 High-Speed LVDS I/O User Guide](#)  
Provides the list of I/O standards supported in single supply and dual supply devices.

## Switching Characteristics

This section provides the performance characteristics of Intel MAX 10 core and periphery blocks.

<sup>(18)</sup> V<sub>IN</sub> range: 0 V ≤ V<sub>IN</sub> ≤ 1.85 V.

<sup>(19)</sup> R<sub>L</sub> range: 90 ≤ R<sub>L</sub> ≤ 110 Ω.

<sup>(20)</sup> Low V<sub>OD</sub> setting is only supported for RSDS standard.

<sup>(22)</sup> No fixed V<sub>IN</sub>, V<sub>OD</sub>, and V<sub>OS</sub> specifications for Bus LVDS (BLVDS). They are dependent on the system topology.

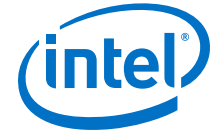
<sup>(23)</sup> Mini-LVDS, RSDS, and Point-to-Point Differential Signaling (PPDS) standards are only supported at the output pins for Intel MAX 10 devices.

<sup>(24)</sup> Supported with requirement of an external level shift

<sup>(25)</sup> Sub-LVDS input buffer is using 2.5 V differential buffer.

<sup>(26)</sup> Differential output depends on the values of the external termination resistors.

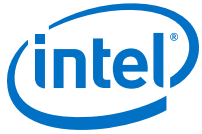
<sup>(27)</sup> Differential output offset voltage depends on the values of the external termination resistors.



| Symbol                                      | Parameter                                                        | Condition                                                                                           | Min | Typ | Max   | Unit |
|---------------------------------------------|------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------|-----|-----|-------|------|
| $f_{VCO}$ <sup>(29)</sup>                   | PLL internal voltage-controlled oscillator (VCO) operating range | —                                                                                                   | 600 | —   | 1300  | MHz  |
| $f_{INDUTY}$                                | Input clock duty cycle                                           | —                                                                                                   | 40  | —   | 60    | %    |
| $t_{INJITTER\_CCJ}$ <sup>(30)</sup>         | Input clock cycle-to-cycle jitter                                | $F_{INPFD} \geq 100$ MHz                                                                            | —   | —   | 0.15  | UI   |
|                                             |                                                                  | $F_{INPFD} < 100$ MHz                                                                               | —   | —   | ±750  | ps   |
| $f_{OUT\_EXT}$ <sup>(28)</sup>              | PLL output frequency for external clock output                   | —                                                                                                   | —   | —   | 472.5 | MHz  |
| $f_{OUT}$                                   | PLL output frequency to global clock                             | –6 speed grade                                                                                      | —   | —   | 472.5 | MHz  |
|                                             |                                                                  | –7 speed grade                                                                                      | —   | —   | 450   | MHz  |
|                                             |                                                                  | –8 speed grade                                                                                      | —   | —   | 402.5 | MHz  |
| $t_{OUTDUTY}$                               | Duty cycle for external clock output                             | Duty cycle set to 50%                                                                               | 45  | 50  | 55    | %    |
| $t_{LOCK}$                                  | Time required to lock from end of device configuration           | —                                                                                                   | —   | —   | 1     | ms   |
| $t_{DLOCK}$                                 | Time required to lock dynamically                                | After switchover, reconfiguring any non-post-scale counters or delays, or when areset is deasserted | —   | —   | 1     | ms   |
| $t_{OUTJITTER\_PERIOD\_IO}$ <sup>(31)</sup> | Regular I/O period jitter                                        | $F_{OUT} \geq 100$ MHz                                                                              | —   | —   | 650   | ps   |
|                                             |                                                                  | $F_{OUT} < 100$ MHz                                                                                 | —   | —   | 75    | mUI  |
| $t_{OUTJITTER\_CCJ\_IO}$ <sup>(31)</sup>    | Regular I/O cycle-to-cycle jitter                                | $F_{OUT} \geq 100$ MHz                                                                              | —   | —   | 650   | ps   |
|                                             |                                                                  | $F_{OUT} < 100$ MHz                                                                                 | —   | —   | 75    | mUI  |

continued...

- <sup>(29)</sup> The VCO frequency reported by the Intel Quartus Prime software in the PLL summary section of the compilation report takes into consideration the VCO post-scale counter K value. Therefore, if the counter K has a value of 2, the frequency reported can be lower than the  $f_{VCO}$  specification.
- <sup>(30)</sup> A high input jitter directly affects the PLL output jitter. To have low PLL output clock jitter, you must provide a clean clock source, which is less than 200 ps.
- <sup>(31)</sup> Peak-to-peak jitter with a probability level of  $10^{-12}$  (14 sigma, 99.9999999974404% confidence level). The output jitter specification applies to the intrinsic jitter of the PLL, when an input jitter of 30 ps is applied.



| Symbol           | Parameter                                         | Condition | Min | Typ                 | Max | Unit           |
|------------------|---------------------------------------------------|-----------|-----|---------------------|-----|----------------|
| $t_{PLL\_PSERR}$ | Accuracy of PLL phase shift                       | —         | —   | —                   | ±50 | ps             |
| $t_{ARESET}$     | Minimum pulse width on areset signal.             | —         | 10  | —                   | —   | ns             |
| $t_{CONFIGPLL}$  | Time required to reconfigure scan chains for PLLs | —         | —   | 3.5 <sup>(32)</sup> | —   | SCANCLK cycles |
| $f_{SCANCLK}$    | scanclk frequency                                 | —         | —   | —                   | 100 | MHz            |

**Table 28. PLL Specifications for Intel MAX 10 Single Supply Devices**

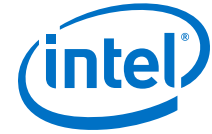
For V36 package, the PLL specification is based on single supply devices.

| Symbol                                          | Parameter                                    | Condition              | Max | Unit |
|-------------------------------------------------|----------------------------------------------|------------------------|-----|------|
| $t_{OUTJITTER\_PERIOD\_DEDCLK}$ <sup>(31)</sup> | Dedicated clock output period jitter         | $F_{OUT} \geq 100$ MHz | 660 | ps   |
|                                                 |                                              | $F_{OUT} < 100$ MHz    | 66  | mUI  |
| $t_{OUTJITTER\_CCJ\_DEDCLK}$ <sup>(31)</sup>    | Dedicated clock output cycle-to-cycle jitter | $F_{OUT} \geq 100$ MHz | 660 | ps   |
|                                                 |                                              | $F_{OUT} < 100$ MHz    | 66  | mUI  |

**Table 29. PLL Specifications for Intel MAX 10 Dual Supply Devices**

| Symbol                                          | Parameter                                    | Condition              | Max | Unit |
|-------------------------------------------------|----------------------------------------------|------------------------|-----|------|
| $t_{OUTJITTER\_PERIOD\_DEDCLK}$ <sup>(31)</sup> | Dedicated clock output period jitter         | $F_{OUT} \geq 100$ MHz | 300 | ps   |
|                                                 |                                              | $F_{OUT} < 100$ MHz    | 30  | mUI  |
| $t_{OUTJITTER\_CCJ\_DEDCLK}$ <sup>(31)</sup>    | Dedicated clock output cycle-to-cycle jitter | $F_{OUT} \geq 100$ MHz | 300 | ps   |
|                                                 |                                              | $F_{OUT} < 100$ MHz    | 30  | mUI  |

<sup>(32)</sup> With 100 MHz scanclk frequency.



## ADC Performance Specifications

### Single Supply Devices ADC Performance Specifications

**Table 34. ADC Performance Specifications for Intel MAX 10 Single Supply Devices**

| Parameter                            |                            | Symbol        | Condition                            | Min                 | Typ             | Max           | Unit |
|--------------------------------------|----------------------------|---------------|--------------------------------------|---------------------|-----------------|---------------|------|
| ADC resolution                       |                            | —             | —                                    | —                   | —               | 12            | bits |
| ADC supply voltage                   |                            | $V_{CC\_ONE}$ | —                                    | 2.85                | 3.0/3.3         | 3.465         | V    |
| External reference voltage           |                            | $V_{REF}$     | —                                    | $V_{CC\_ONE} - 0.5$ | —               | $V_{CC\_ONE}$ | V    |
| Sampling rate                        |                            | $F_S$         | Accumulative sampling rate           | —                   | —               | 1             | MSPS |
| Operating junction temperature range |                            | $T_J$         | —                                    | −40                 | 25              | 125           | °C   |
| Analog input voltage                 |                            | $V_{IN}$      | Prescaler disabled                   | 0                   | —               | $V_{REF}$     | V    |
|                                      |                            |               | Prescaler enabled <sup>(35)</sup>    | 0                   | —               | 3.6           | V    |
| Input resistance                     |                            | $R_{IN}$      | —                                    | —                   | <sup>(36)</sup> | —             | —    |
| Input capacitance                    |                            | $C_{IN}$      | —                                    | —                   | <sup>(36)</sup> | —             | —    |
| DC Accuracy                          | Offset error and drift     | $E_{offset}$  | Prescaler disabled                   | −0.2                | —               | 0.2           | %FS  |
|                                      |                            |               | Prescaler enabled                    | −0.5                | —               | 0.5           | %FS  |
|                                      | Gain error and drift       | $E_{gain}$    | Prescaler disabled                   | −0.5                | —               | 0.5           | %FS  |
|                                      |                            |               | Prescaler enabled                    | −0.75               | —               | 0.75          | %FS  |
|                                      | Differential non linearity | DNL           | External $V_{REF}$ , no missing code | −0.9                | —               | 0.9           | LSB  |
|                                      |                            |               | Internal $V_{REF}$ , no missing code | −1                  | —               | 1.7           | LSB  |

*continued...*

<sup>(35)</sup> Prescaler function divides the analog input voltage by half. The analog input handles up to 3.6 V for the Intel MAX 10 single supply devices.

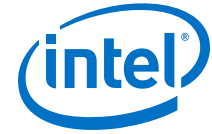
<sup>(36)</sup> Download the SPICE models for simulation.



| Symbol                                | Parameter                                                                                                              | Mode                               | -I6, -A6, -C7, -I7 |     |     | -A7 |     |     | -C8 |     |     | Unit |
|---------------------------------------|------------------------------------------------------------------------------------------------------------------------|------------------------------------|--------------------|-----|-----|-----|-----|-----|-----|-----|-----|------|
|                                       |                                                                                                                        |                                    | Min                | Typ | Max | Min | Typ | Max | Min | Typ | Max |      |
|                                       |                                                                                                                        | ×4                                 | 40                 | —   | 300 | 40  | —   | 300 | 40  | —   | 300 | Mbps |
|                                       |                                                                                                                        | ×2                                 | 20                 | —   | 300 | 20  | —   | 300 | 20  | —   | 300 | Mbps |
|                                       |                                                                                                                        | ×1                                 | 10                 | —   | 300 | 10  | —   | 300 | 10  | —   | 300 | Mbps |
| t <sub>DUTY</sub>                     | Duty cycle on transmitter output clock                                                                                 | —                                  | 45                 | —   | 55  | 45  | —   | 55  | 45  | —   | 55  | %    |
| TCCS <sup>(53)</sup>                  | Transmitter channel-to-channel skew                                                                                    | —                                  | —                  | —   | 300 | —   | —   | 300 | —   | —   | 300 | ps   |
| t <sub>x jitter</sub> <sup>(54)</sup> | Output jitter (high-speed I/O performance pin)                                                                         | —                                  | —                  | —   | 425 | —   | —   | 425 | —   | —   | 425 | ps   |
|                                       | Output jitter (low-speed I/O performance pin)                                                                          | —                                  | —                  | —   | 470 | —   | —   | 470 | —   | —   | 470 | ps   |
| t <sub>RISE</sub>                     | Rise time                                                                                                              | 20 – 80%, C <sub>LOAD</sub> = 5 pF | —                  | 500 | —   | —   | 500 | —   | —   | 500 | —   | ps   |
| t <sub>FALL</sub>                     | Fall time                                                                                                              | 20 – 80%, C <sub>LOAD</sub> = 5 pF | —                  | 500 | —   | —   | 500 | —   | —   | 500 | —   | ps   |
| t <sub>LOCK</sub>                     | Time required for the PLL to lock, after CONF_DONE signal goes high, indicating the completion of device configuration | —                                  | —                  | —   | 1   | —   | —   | 1   | —   | —   | 1   | ms   |

<sup>(53)</sup> TCCS specifications apply to I/O banks from the same side only.

<sup>(54)</sup> TX jitter is the jitter induced from core noise and I/O switching noise.



## Emulated LVDS\_E\_3R, SLVS, and Sub-LVDS Transmitter Timing Specifications

### Single Supply Devices Emulated LVDS\_E\_3R Transmitter Timing Specifications

**Table 43. Emulated LVDS\_E\_3R Transmitter Timing Specifications for Intel MAX 10 Single Supply Devices**

Emulated **LVDS\_E\_3R** transmitters are supported at the output pin of all I/O banks.

| Symbol            | Parameter                                              | Mode | -C7, -I7 |     |       | -A7 |     |     | -C8 |     |     | Unit |
|-------------------|--------------------------------------------------------|------|----------|-----|-------|-----|-----|-----|-----|-----|-----|------|
|                   |                                                        |      | Min      | Typ | Max   | Min | Typ | Max | Min | Typ | Max |      |
| f <sub>HCLK</sub> | Input clock frequency (high-speed I/O performance pin) | ×10  | 5        | —   | 142.5 | 5   | —   | 100 | 5   | —   | 100 | MHz  |
|                   |                                                        | ×8   | 5        | —   | 142.5 | 5   | —   | 100 | 5   | —   | 100 | MHz  |
|                   |                                                        | ×7   | 5        | —   | 142.5 | 5   | —   | 100 | 5   | —   | 100 | MHz  |
|                   |                                                        | ×4   | 5        | —   | 142.5 | 5   | —   | 100 | 5   | —   | 100 | MHz  |
|                   |                                                        | ×2   | 5        | —   | 142.5 | 5   | —   | 100 | 5   | —   | 100 | MHz  |
|                   |                                                        | ×1   | 5        | —   | 285   | 5   | —   | 200 | 5   | —   | 200 | MHz  |
| HSIODR            | Data rate (high-speed I/O performance pin)             | ×10  | 100      | —   | 285   | 100 | —   | 200 | 100 | —   | 200 | Mbps |
|                   |                                                        | ×8   | 80       | —   | 285   | 80  | —   | 200 | 80  | —   | 200 | Mbps |
|                   |                                                        | ×7   | 70       | —   | 285   | 70  | —   | 200 | 70  | —   | 200 | Mbps |
|                   |                                                        | ×4   | 40       | —   | 285   | 40  | —   | 200 | 40  | —   | 200 | Mbps |
|                   |                                                        | ×2   | 20       | —   | 285   | 20  | —   | 200 | 20  | —   | 200 | Mbps |
|                   |                                                        | ×1   | 10       | —   | 285   | 10  | —   | 200 | 10  | —   | 200 | Mbps |
| f <sub>HCLK</sub> | Input clock frequency (low-speed I/O performance pin)  | ×10  | 5        | —   | 100   | 5   | —   | 100 | 5   | —   | 100 | MHz  |
|                   |                                                        | ×8   | 5        | —   | 100   | 5   | —   | 100 | 5   | —   | 100 | MHz  |
|                   |                                                        | ×7   | 5        | —   | 100   | 5   | —   | 100 | 5   | —   | 100 | MHz  |
|                   |                                                        | ×4   | 5        | —   | 100   | 5   | —   | 100 | 5   | —   | 100 | MHz  |
|                   |                                                        | ×2   | 5        | —   | 100   | 5   | —   | 100 | 5   | —   | 100 | MHz  |
|                   |                                                        | ×1   | 5        | —   | 200   | 5   | —   | 200 | 5   | —   | 200 | MHz  |
| HSIODR            | Data rate (low-speed I/O performance pin)              | ×10  | 100      | —   | 200   | 100 | —   | 200 | 100 | —   | 200 | Mbps |

*continued...*



## LVDS, TMDs, HiSpi, SLVS, and Sub-LVDS Receiver Timing Specifications

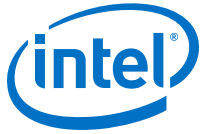
### Single Supply Devices LVDS Receiver Timing Specifications

**Table 45. LVDS Receiver Timing Specifications for Intel MAX 10 Single Supply Devices**

LVDS receivers are supported at all banks.

| Symbol            | Parameter                                              | Mode | -C7, -I7 |     | -A7 |     | -C8 |     | Unit |
|-------------------|--------------------------------------------------------|------|----------|-----|-----|-----|-----|-----|------|
|                   |                                                        |      | Min      | Max | Min | Max | Min | Max |      |
| $f_{\text{HCLK}}$ | Input clock frequency (high-speed I/O performance pin) | ×10  | 5        | 145 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×8   | 5        | 145 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×7   | 5        | 145 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×4   | 5        | 145 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×2   | 5        | 145 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×1   | 5        | 290 | 5   | 200 | 5   | 200 | MHz  |
| HSIODR            | Data rate (high-speed I/O performance pin)             | ×10  | 100      | 290 | 100 | 200 | 100 | 200 | Mbps |
|                   |                                                        | ×8   | 80       | 290 | 80  | 200 | 80  | 200 | Mbps |
|                   |                                                        | ×7   | 70       | 290 | 70  | 200 | 70  | 200 | Mbps |
|                   |                                                        | ×4   | 40       | 290 | 40  | 200 | 40  | 200 | Mbps |
|                   |                                                        | ×2   | 20       | 290 | 20  | 200 | 20  | 200 | Mbps |
|                   |                                                        | ×1   | 10       | 290 | 10  | 200 | 10  | 200 | Mbps |
| $f_{\text{HCLK}}$ | Input clock frequency (low-speed I/O performance pin)  | ×10  | 5        | 100 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×8   | 5        | 100 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×7   | 5        | 100 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×4   | 5        | 100 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×2   | 5        | 100 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×1   | 5        | 200 | 5   | 200 | 5   | 200 | MHz  |
| HSIODR            | Data rate (low-speed I/O performance pin)              | ×10  | 100      | 200 | 100 | 200 | 100 | 200 | Mbps |

*continued...*



| Symbol                        | Parameter                                                                                                              | Mode | -C7, -I7 |       | -A7 |       | -C8 |       | Unit |
|-------------------------------|------------------------------------------------------------------------------------------------------------------------|------|----------|-------|-----|-------|-----|-------|------|
|                               |                                                                                                                        |      | Min      | Max   | Min | Max   | Min | Max   |      |
|                               |                                                                                                                        | ×8   | 80       | 200   | 80  | 200   | 80  | 200   | Mbps |
|                               |                                                                                                                        | ×7   | 70       | 200   | 70  | 200   | 70  | 200   | Mbps |
|                               |                                                                                                                        | ×4   | 40       | 200   | 40  | 200   | 40  | 200   | Mbps |
|                               |                                                                                                                        | ×2   | 20       | 200   | 20  | 200   | 20  | 200   | Mbps |
|                               |                                                                                                                        | ×1   | 10       | 200   | 10  | 200   | 10  | 200   | Mbps |
| SW                            | Sampling window (high-speed I/O performance pin)                                                                       | —    | —        | 910   | —   | 910   | —   | 910   | ps   |
|                               | Sampling window (low-speed I/O performance pin)                                                                        | —    | —        | 1,110 | —   | 1,110 | —   | 1,110 | ps   |
| $t_{x \text{ jitter}}^{(71)}$ | Input jitter                                                                                                           | —    | —        | 1,000 | —   | 1,000 | —   | 1,000 | ps   |
| $t_{\text{LOCK}}$             | Time required for the PLL to lock, after CONF_DONE signal goes high, indicating the completion of device configuration | —    | —        | 1     | —   | 1     | —   | 1     | ms   |

## Dual Supply Devices LVDS, TMDS, HiSpi, SLVS, and Sub-LVDS Receiver Timing Specifications

**Table 46. LVDS, TMDS, HiSpi, SLVS, and Sub-LVDS Receiver Timing Specifications for Intel MAX 10 Dual Supply Devices**

LVDS, TMDS, HiSpi, SLVS, and Sub-LVDS receivers are supported at all banks.

| Symbol            | Parameter                                              | Mode | -I6, -A6, -C7, -I7 |     | -A7 |     | -C8 |     | Unit |
|-------------------|--------------------------------------------------------|------|--------------------|-----|-----|-----|-----|-----|------|
|                   |                                                        |      | Min                | Max | Min | Max | Min | Max |      |
| $f_{\text{HCLK}}$ | Input clock frequency (high-speed I/O performance pin) | ×10  | 5                  | 350 | 5   | 320 | 5   | 320 | MHz  |
|                   |                                                        | ×8   | 5                  | 360 | 5   | 320 | 5   | 320 | MHz  |
|                   |                                                        | ×7   | 5                  | 350 | 5   | 320 | 5   | 320 | MHz  |
|                   |                                                        | ×4   | 5                  | 360 | 5   | 320 | 5   | 320 | MHz  |

*continued...*

<sup>(71)</sup> TX jitter is the jitter induced from core noise and I/O switching noise.



| Symbol             | Parameter                                             | Mode | -I6, -A6, -C7, -I7 |     | -A7 |     | -C8 |     | Unit |
|--------------------|-------------------------------------------------------|------|--------------------|-----|-----|-----|-----|-----|------|
|                    |                                                       |      | Min                | Max | Min | Max | Min | Max |      |
|                    |                                                       | ×2   | 5                  | 360 | 5   | 320 | 5   | 320 | MHz  |
|                    |                                                       | ×1   | 5                  | 360 | 5   | 320 | 5   | 320 | MHz  |
| HSIODR             | Data rate (high-speed I/O performance pin)            | ×10  | 100                | 700 | 100 | 640 | 100 | 640 | Mbps |
|                    |                                                       | ×8   | 80                 | 720 | 80  | 640 | 80  | 640 | Mbps |
|                    |                                                       | ×7   | 70                 | 700 | 70  | 640 | 70  | 640 | Mbps |
|                    |                                                       | ×4   | 40                 | 720 | 40  | 640 | 40  | 640 | Mbps |
|                    |                                                       | ×2   | 20                 | 720 | 20  | 640 | 20  | 640 | Mbps |
|                    |                                                       | ×1   | 10                 | 360 | 10  | 320 | 10  | 320 | Mbps |
|                    |                                                       |      |                    |     |     |     |     |     |      |
| f <sub>HSCLK</sub> | Input clock frequency (low-speed I/O performance pin) | ×10  | 5                  | 150 | 5   | 150 | 5   | 150 | MHz  |
|                    |                                                       | ×8   | 5                  | 150 | 5   | 150 | 5   | 150 | MHz  |
|                    |                                                       | ×7   | 5                  | 150 | 5   | 150 | 5   | 150 | MHz  |
|                    |                                                       | ×4   | 5                  | 150 | 5   | 150 | 5   | 150 | MHz  |
|                    |                                                       | ×2   | 5                  | 150 | 5   | 150 | 5   | 150 | MHz  |
|                    |                                                       | ×1   | 5                  | 300 | 5   | 300 | 5   | 300 | MHz  |
|                    |                                                       |      |                    |     |     |     |     |     |      |
| HSIODR             | Data rate (low-speed I/O performance pin)             | ×10  | 100                | 300 | 100 | 300 | 100 | 300 | Mbps |
|                    |                                                       | ×8   | 80                 | 300 | 80  | 300 | 80  | 300 | Mbps |
|                    |                                                       | ×7   | 70                 | 300 | 70  | 300 | 70  | 300 | Mbps |
|                    |                                                       | ×4   | 40                 | 300 | 40  | 300 | 40  | 300 | Mbps |
|                    |                                                       | ×2   | 20                 | 300 | 20  | 300 | 20  | 300 | Mbps |
|                    |                                                       | ×1   | 10                 | 300 | 10  | 300 | 10  | 300 | Mbps |
|                    |                                                       |      |                    |     |     |     |     |     |      |
| SW                 | Sampling window (high-speed I/O performance pin)      | —    | —                  | 510 | —   | 510 | —   | 510 | ps   |
| continued...       |                                                       |      |                    |     |     |     |     |     |      |



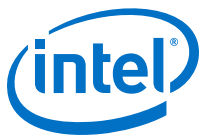
## JTAG Timing Parameters

**Table 49. JTAG Timing Parameters for Intel MAX 10 Devices**

The values are based on  $C_L = 10$  pF of TD0.

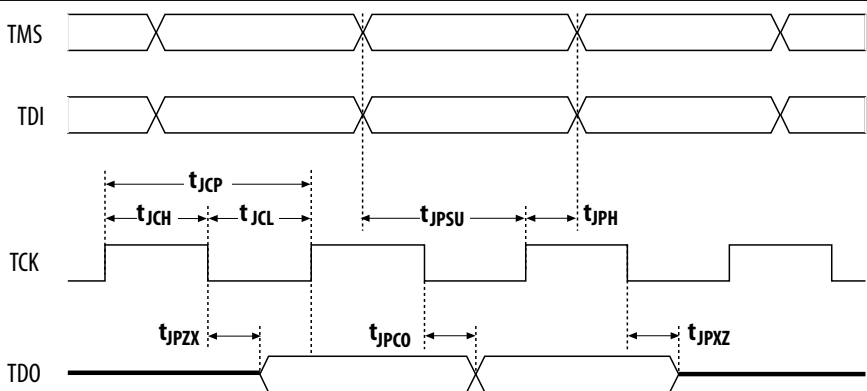
The affected Boundary Scan Test (BST) instructions are SAMPLE/PRELOAD, EXTEST, INTEST, and CHECK\_STATUS.

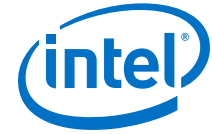
| Symbol          | Parameter                                | Non-BST and non-CONFIG_IO Operation |                                                                                                                                                             | BST and CONFIG_IO Operation |                                                                                                                                                             | Unit |
|-----------------|------------------------------------------|-------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
|                 |                                          | Minimum                             | Maximum                                                                                                                                                     | Minimum                     | Maximum                                                                                                                                                     |      |
| $t_{JCP}$       | TCK clock period                         | 40                                  | —                                                                                                                                                           | 50                          | —                                                                                                                                                           | ns   |
| $t_{JCH}$       | TCK clock high time                      | 20                                  | —                                                                                                                                                           | 25                          | —                                                                                                                                                           | ns   |
| $t_{JCL}$       | TCK clock low time                       | 20                                  | —                                                                                                                                                           | 25                          | —                                                                                                                                                           | ns   |
| $t_{JPSU\_TDI}$ | JTAG port setup time                     | 2                                   | —                                                                                                                                                           | 2                           | —                                                                                                                                                           | ns   |
| $t_{JPSU\_TMS}$ | JTAG port setup time                     | 3                                   | —                                                                                                                                                           | 3                           | —                                                                                                                                                           | ns   |
| $t_{JPH}$       | JTAG port hold time                      | 10                                  | —                                                                                                                                                           | 10                          | —                                                                                                                                                           | ns   |
| $t_{JPCO}$      | JTAG port clock to output                | —                                   | <ul style="list-style-type: none"><li>15 (for <math>V_{CCIO} = 3.3, 3.0,</math> and 2.5 V)</li><li>17 (for <math>V_{CCIO} = 1.8</math> and 1.5 V)</li></ul> | —                           | <ul style="list-style-type: none"><li>18 (for <math>V_{CCIO} = 3.3, 3.0,</math> and 2.5 V)</li><li>20 (for <math>V_{CCIO} = 1.8</math> and 1.5 V)</li></ul> | ns   |
| $t_{JPZX}$      | JTAG port high impedance to valid output | —                                   | <ul style="list-style-type: none"><li>15 (for <math>V_{CCIO} = 3.3, 3.0,</math> and 2.5 V)</li><li>17 (for <math>V_{CCIO} = 1.8</math> and 1.5 V)</li></ul> | —                           | <ul style="list-style-type: none"><li>15 (for <math>V_{CCIO} = 3.3, 3.0,</math> and 2.5 V)</li><li>17 (for <math>V_{CCIO} = 1.8</math> and 1.5 V)</li></ul> | ns   |
| $t_{JPXZ}$      | JTAG port valid output to high impedance | —                                   | <ul style="list-style-type: none"><li>15 (for <math>V_{CCIO} = 3.3, 3.0,</math> and 2.5 V)</li><li>17 (for <math>V_{CCIO} = 1.8</math> and 1.5 V)</li></ul> | —                           | <ul style="list-style-type: none"><li>15 (for <math>V_{CCIO} = 3.3, 3.0,</math> and 2.5 V)</li><li>17 (for <math>V_{CCIO} = 1.8</math> and 1.5 V)</li></ul> | ns   |



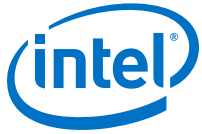
## Glossary

**Table 59. Glossary**

| Term                                         | Definition                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|----------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| JTAG Timing Specifications                   |                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| $R_L$                                        | Receiver differential input discrete resistor (external to Intel MAX 10 devices).                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| RSKM (Receiver input skew margin)            | HIGH-SPEED I/O block: The total margin left after accounting for the sampling window and TCCS. $RSKM = (TUI - SW - TCCS) / 2$ .                                                                                                                                                                                                                                                                                                                                                                                                                         |
| Sampling window (SW)                         | HIGH-SPEED I/O Block: The period of time during which the data must be valid to capture it correctly. The setup and hold times determine the ideal strobe position in the sampling window.                                                                                                                                                                                                                                                                                                                                                              |
| Single-ended voltage referenced I/O standard | The AC input signal values indicate the voltage levels at which the receiver must meet its timing specifications. The DC input signal values indicate the voltage levels at which the final logic state of the receiver is unambiguously defined. After the receiver input crosses the AC value, the receiver changes to the new logic state.<br>The new logic state is then maintained as long as the input stays beyond the DC threshold. This approach is intended to provide predictable receiver timing in the presence of input waveform ringing. |
| $t_c$                                        | High-speed receiver/transmitter input and output clock period.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| TCCS (Channel-to- channel-skew)              | HIGH-SPEED I/O block: The timing difference between the fastest and slowest output edges, including $t_{CO}$ variation and clock skew. The clock is included in the TCCS measurement.                                                                                                                                                                                                                                                                                                                                                                   |
| $t_{cin}$                                    | Delay from clock pad to I/O input register.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| $t_{CO}$                                     | Delay from clock pad to I/O output.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| $t_{cout}$                                   | Delay from clock pad to I/O output register.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| continued...                                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |



| Term                          | Definition                                                                                                                                                                                    |
|-------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| t <sub>DUTY</sub>             | HIGH-SPEED I/O Block: Duty cycle on high-speed transmitter output clock.                                                                                                                      |
| t <sub>FALL</sub>             | Signal high-to-low transition time (80–20%).                                                                                                                                                  |
| t <sub>H</sub>                | Input register hold time.                                                                                                                                                                     |
| Timing Unit Interval (TUI)    | HIGH-SPEED I/O block: The timing budget allowed for skew, propagation delays, and data sampling window. (TUI = 1/(Receiver Input Clock Frequency Multiplication Factor) = t <sub>C</sub> /w). |
| t <sub>INJITTER</sub>         | Period jitter on PLL clock input.                                                                                                                                                             |
| t <sub>OUTJITTER_DEDCLK</sub> | Period jitter on dedicated clock output driven by a PLL.                                                                                                                                      |
| t <sub>OUTJITTER_IO</sub>     | Period jitter on general purpose I/O driven by a PLL.                                                                                                                                         |
| t <sub>pllcin</sub>           | Delay from PLL inclk pad to I/O input register.                                                                                                                                               |
| t <sub>pllcout</sub>          | Delay from PLL inclk pad to I/O output register.                                                                                                                                              |
| t <sub>RISE</sub>             | Signal low-to-high transition time (20–80%).                                                                                                                                                  |
| t <sub>SU</sub>               | Input register setup time.                                                                                                                                                                    |
| V <sub>CM(DC)</sub>           | DC common mode input voltage.                                                                                                                                                                 |
| V <sub>DIF(AC)</sub>          | AC differential input voltage: The minimum AC input differential voltage required for switching.                                                                                              |
| V <sub>DIF(DC)</sub>          | DC differential input voltage: The minimum DC input differential voltage required for switching.                                                                                              |
| V <sub>HYS</sub>              | Hysteresis for Schmitt trigger input.                                                                                                                                                         |
| V <sub>ICM</sub>              | Input common mode voltage: The common mode of the differential signal at the receiver.                                                                                                        |
| V <sub>ID</sub>               | Input differential Voltage Swing: The difference in voltage between the positive and complementary conductors of a differential transmission at the receiver.                                 |
| V <sub>IH</sub>               | Voltage input high: The minimum positive voltage applied to the input which is accepted by the device as a logic high.                                                                        |
| V <sub>IH(AC)</sub>           | High-level AC input voltage.                                                                                                                                                                  |
| V <sub>IH(DC)</sub>           | High-level DC input voltage.                                                                                                                                                                  |
| V <sub>IL</sub>               | Voltage input low: The maximum positive voltage applied to the input which is accepted by the device as a logic low.                                                                          |
| V <sub>IL (AC)</sub>          | Low-level AC input voltage.                                                                                                                                                                   |
| V <sub>IL (DC)</sub>          | Low-level DC input voltage.                                                                                                                                                                   |
| V <sub>IN</sub>               | DC input voltage.                                                                                                                                                                             |
| continued...                  |                                                                                                                                                                                               |



| Date           | Version    | Changes                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
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|                |            | <ul style="list-style-type: none"><li>Updated SSTL-2 Class I and II I/O standard specifications for JEDEC compliance as follows:<ul style="list-style-type: none"><li>VIL(AC) Max: Updated from <math>V_{REF} - 0.35</math> to <math>V_{REF} - 0.31</math></li><li>VIH(AC) Min: Updated from <math>V_{REF} + 0.35</math> to <math>V_{REF} + 0.31</math></li></ul></li><li>Added a note to BLVDS in Differential I/O Standards Specifications for Intel MAX 10 Devices table: BLVDS TX is not supported in single supply devices.</li><li>Added a link to MAX 10 High-Speed LVDS I/O User Guide for the list of I/O standards supported in single supply and dual supply devices.</li><li>Added a statement in PLL Specifications for Intel MAX 10 Single Supply Device table: For V36 package, the PLL specification is based on single supply devices.</li><li>Added Internal Oscillator Specifications from Intel MAX 10 Clocking and PLL User Guide.</li><li>Added UFM specifications for serial interface.</li><li>Updated total harmonic distortion (THD) specifications as follows:<ul style="list-style-type: none"><li>Single supply devices: Updated from 65 dB to -65 dB</li><li>Dual supply devices: Updated from 70 dB to -70 dB (updated from 65 dB to -65 dB for dual function pin)</li></ul></li><li>Added condition for On-Chip Temperature Sensor—Absolute accuracy parameter in ADC Performance Specifications for Intel MAX 10 Dual Supply Devices table. The condition is: with 64 samples averaging.</li><li>Updated the description in Periphery Performance Specifications to mention that proper timing closure is required in design.</li><li>Updated HSIODR and <math>f_{HCLK}</math> specifications for x10 and x7 modes in True LVDS Transmitter Timing Specifications for Intel MAX 10 Dual Supply Devices.</li><li>Added specifications for low-speed I/O performance pin sampling window in LVDS Receiver Timing Specifications for Intel MAX 10 Single Supply Devices table: Max = 900 ps for -C7, -I7, -A7, and -C8 speed grades.</li><li>Added <math>t_{RU\_nCONFIG}</math> and <math>t_{RU\_nRSTIMER}</math> specifications for different devices in Remote System Upgrade Circuitry Timing Specifications for Intel MAX 10 Devices table.</li><li>Removed the word "internal oscillator" in User Watchdog Timer Specifications for Intel MAX 10 Devices table to avoid confusion.</li><li>Added IOE programmable delay specifications.</li></ul> |
| September 2014 | 2014.09.22 | Initial release.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |